

N-Channel Enhancement Mode MOSFET

Description

The ACE2302 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and Battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

Features

- 20V/3.6A, RDS(ON)= $80m\Omega@V_{GS}=4.5V$
- 20V/3.1A, RDS(ON)= $95m\Omega@V_{GS}=2.5V$
- Super high density cell design for extremely low R_{DS(ON)}
- Exceptional on-resistance and maximum DC current capability

Application

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

Absolute Maximum Ratings

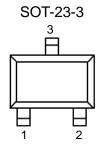
Parameter	Symbol	Max	Unit		
Drain-Source Voltage	V_{DSS}	20	٧		
Gate-Source Voltage	V_{GSS}	±12	V		
Continuous Drain Current (T _J =150°C)	T _A =25°℃	l _D	3.2	Α	
Continuous Diain Current (1)=130 ()	T _A =70°C		2.6		
Pulsed Drain Current	I _{DM}	10	Α		
Continuous Source Current (Diode Co	Is	1.6	Α		
Power Dissipation T _A =		P _D	1.25	W	
Fower Dissipation	T _A =70°C	ΓD	0.8	VV	
Operating Junction Temperature		T_J	150	°C	
Storage Temperature Range	T _{STG}	-55/150	°C		
Thermal Resistance-Junction to Ambient		$R_{\theta JA}$	100	°C/W	



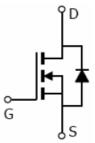


N-Channel Enhancement Mode MOSFET

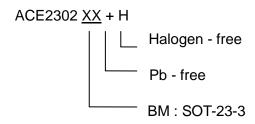
Packaging Type



SOT-23-3	Description		
1	Gate		
2	Source		
3	Drain		



Ordering information



Electrical Characteristics

 $T_A=25^{\circ}C$, unless otherwise noted

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250 uA	20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_D=V_{GS}$, $I_D=250uA$	0.45		1.2	
Gate Leakage Current	I _{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$			±100	nA
Zero Gate Voltage Drain		V_{DS} =20V, V_{GS} =0V			1	
Current	I _{DSS}	V_{DS} =20V, V_{GS} =0V T_J =55 $^{\circ}$ C			10	uA
On-State Drain Current		VDS≧5V, V _{GS} =4.5V	6			_
	I _{D(ON)}	VDS≧5V, V _{GS} =2.5V	4			Α
Drain-Source	0	V _{GS} =4.5V, I _D =3.6A		0.050	0.080	
On-Resistance	stance R _{DS(ON)}	V _{GS} =2.5V, I _D =3.1A		0.070	0.095	Ω
Forward	gfs	V _{DS} =5V,I _D =3.6A		10		S

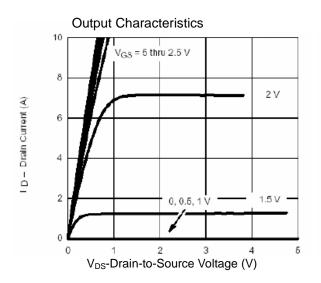


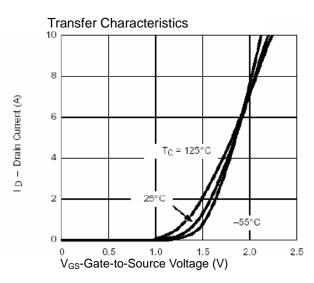
ACE2302

N-Channel Enhancement Mode MOSFET

Transconductance						
Diode Forward Voltage	V_{SD}	I _S =1.6A, V _{GS} =0V		0.85	1.2	V
Dynamic						
Total Gate Charge	Q_g	V _{DS} =10V, V _{GS} =4.5V, I _D =3.6A		5.4	10	
Gate-Source Charge	Q_{gs}			0.65		nC
Gate-Drain Charge	Q_gd			1.4		
Input Capacitance	Ciss	V_{DS} =10V, V_{GS} =0V, f=1MHz		340		
Output Capacitance	Coss			115		pF
Reverse Transfer Capacitance	Crss			33		Pi
Turn-On Time Turn-Off Time	td(on)	V_{DD} =10V, R_L =5.5 Ω , I_D =3.6A,		12	25	
	tr			36	60	nS
	td(off)	V_{GEN} =4.5V, R_{G} =6 Ω		34	60	113
	tf			10	25	

Typical Performance Characteristics



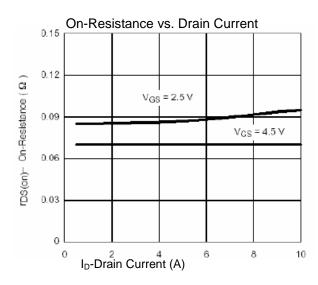


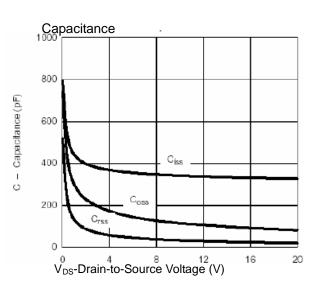


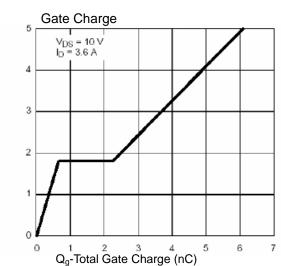
VGS - Gate-to-Source Voltage (V)

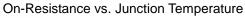
ACE2302

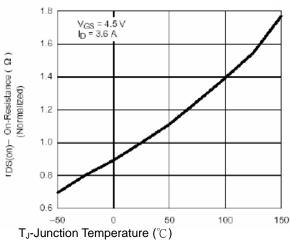
N-Channel Enhancement Mode MOSFET

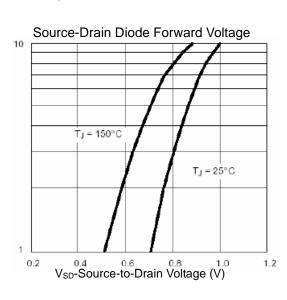




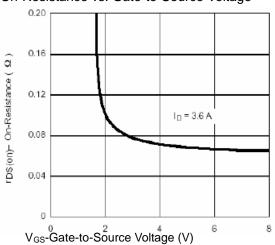








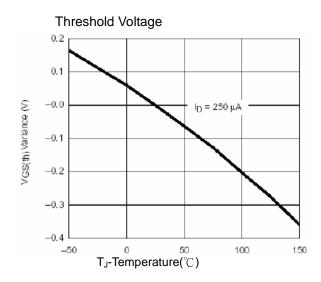
On-Resistance vs. Gate-to-Source Voltage

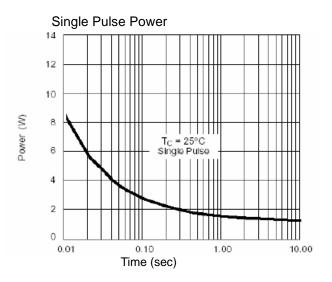


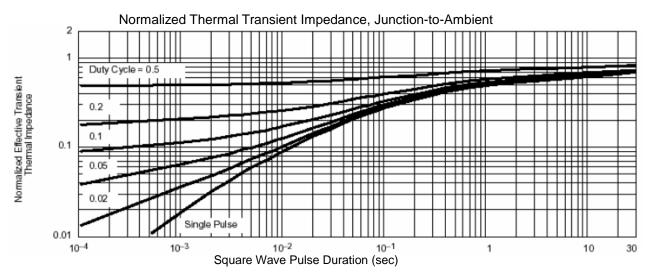


ACE2302

N-Channel Enhancement Mode MOSFET





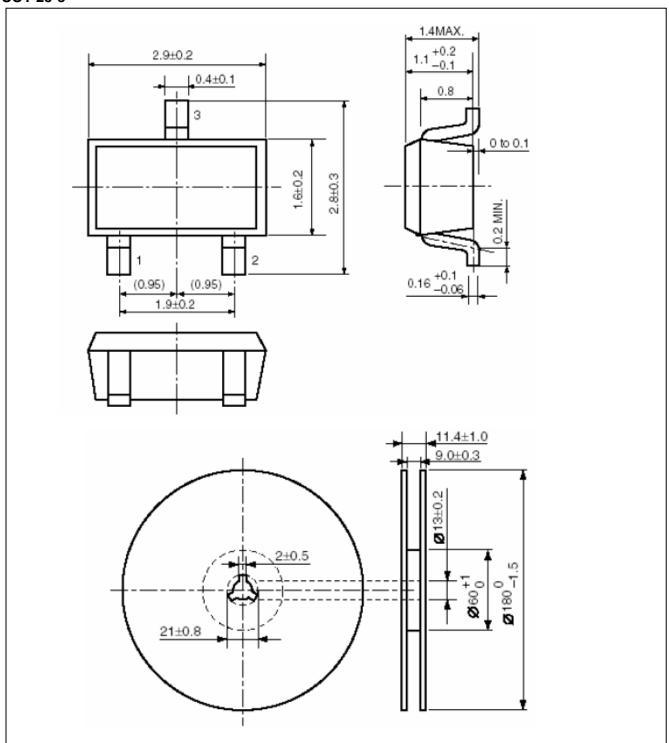




N-Channel Enhancement Mode MOSFET

Packing Information

SOT-23-3





ACE2302 N-Channel Enhancement Mode MOSFET

Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and shoes failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ACE Technology Co., LTD. http://www.ace-ele.com/